Thermal Contact Resistance between Mold Steel and Additively Manufactured Insert for Designing Conformal Channels: An Experimental Study

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Abstract: The focus of this research is on thermal contact resistance between a mold and its insert, specifically inserts made by additive manufacturing (AM). Using a thermal steady-state system and varying contact pressures (0, 50, 75, and 100 bars), we present experimental results of the thermal contact resistance at the contact interface between steel A (1.2344), obtained from an extruded rod, and steel B (1.2709), produced by laser powder bed fusion. Thermal tests were performed for unbonded and bonded configurations. Results showed that increasing the contact pressure allows the system equilibrium to be reached at lower temperatures. Furthermore, thermal tests showed that in the transition zone of the bonded configuration, a well-defined resistance is not formed between the two steel samples as it occurs in the unbonded configuration. For the unbonded configuration, the thermal contact resistance values decrease with increasing applied contact pressure, improving the system’s heat transfer.

Keywords: thermal contact resistance; additive manufacturing; mold thermal management

1. Introduction

In the foundry industry, mold thermal management is a crucial phase of the molding cycle, affecting the parts’ final quality and production time [1]. To optimize this process, it is necessary to develop a cooling channel system that is tailored to the part be cast. In this way, the cooling time can be reduced, resulting in increased production and improved surface and microstructural quality of the casting [2]. Due to the limits of standard drilling processes, the most common mold cooling systems use straight channels. However, this configuration does not provide optimal performance in cooling castings with organic and complex shapes [2,3]. The use of mold inserts is a method to solve issues related to inhomogeneous cooling in complex sections [4–7].

The significant growth and evolution of the metal additive manufacturing (AM) technique have enabled the manufacture of parts with complex geometries directly from a 3D CAD model [8,9]. Thus, this approach has made it feasible to manufacture cooling systems with channels of geometric complexity (conformal cooling), enabling the design of an insert according to the requirements of the geometry of mold cavity [10,11]. The insert is a die part that can reproduce the mold cavity’s intrinsic geometry and enhance cooling in specific and critical sections. Each insert has one or more cooling channels to cool each hot region effectively [12]. However, using two distinct materials (base mold and insert) results in a new interface. The contact between these two materials...
occurs microscopically at various points, which, depending on the corresponding surface roughness values, minimizes the actual contact area. This reduction in the contact area impacts the heat flow across the interface and introduces a thermal resistance known as thermal contact resistance (TCR) at the junction of the two surfaces [13]. TCR is one of the most critical parameters for the thermal analysis of materials. It affects applications with engineering devices that require a high heat flux [14,15], making it difficult to accurately manage the heat and cooling performance of many applications, such as those observed in the aeronautical industry, cryogenics, the nuclear industry, microelectronics, and space vehicles, among others [16–18].

Generally, three methods are used in research on TCR: analytical models [19–21], numerical simulations [22–24], and experimental studies [25–27], which are often the preferred option. It is challenging to create a model or computer method capable of exhaustively computing every solid interface [14]. TCR may be measured experimentally using either a steady-state or transient system, although the one-dimensional steady-state method is the most common.

Numerous investigations of TCR determination for different pairs of materials have been published in the scientific literature. Madhusudana et al. [26] studied the accuracy of contact heat transfer tests and demonstrated that heat loss from samples to the surrounding material occurs when contact pressures are low and samples are weak conductors. Dounghuan Liu et al. [25] studied the TCR between a high-thermal-conductivity C/C material and superalloy Inconel 600, which are widely used in thermal protection structures to increase heat transmission. The authors found that the TCR value is pressure- and temperature-sensitive. Cousineau et al. [28] described the thermal properties of electrical machine lamination stacks, measuring thermal conductivity and identifying variables that influence TCR between laminations in a stack, including surface quality and contact pressure. Le et al. [29] built equipment to measure the TCR of a low-thermal-conductivity fiber insulator under high temperatures and atmospheric pressure conditions and determined that the TCR decreases with increasing pressure. Choi et al. [30] designed an experimental apparatus for accurate testing, using a steady-state method to evaluate thermal contact conductance between metals at temperatures below 100 K. Recent research conducted by Ren et al. [11] on the TCR at three contact interfaces of carbon-fiber-reinforced silicon carbide composite revealed that the TCR decreases with increasing pressure and temperature.

The aim of this study is to fill the dearth in the literature with respect to experimental studies on TCR in mold/insert contact interfaces, particularly for AM-machined inserts. Here, we describe the experimental determination of TCR at the interface contact between a casting mold steel (Orvar 2M) and steel for inserts produced via AM (M300). The TCR values for this contact pair were obtained through steady-state laboratory testing using different contact pressures. In addition, the AM steel was deposited directly onto the Orvar 2M steel to link the identical pair of steels. We also investigated the heat behavior of this steel combination.

2. Materials and Methods
2.1. Sample Preparations

The two studied steels were designated A and B in the interest of simplicity. Steel A is a 1.2344 steel (Orvar 2M steel) used to manufacture casting molds. It has a density of 7.8 g/cm$^3$ and a thermal conductivity ranging from 25 to 30 W/m·K between room temperature and 700 °C, respectively. Steel B is a 1.2709 steel obtained by AM (M300 steel) that may be utilized for inserts. The bulk steel resulting from steel B obtained by AM (by laser powder bed fusion process) processing has a density of 8.1 g/cm$^3$ and a thermal conductivity ranging from 14.2 to 28.6 W/m·K between room temperature and 1300 °C, respectively. Two contact configurations were investigated between the two steels. Configuration A/B considers the contact interface between steels A and B as unbonded. Arrangement A.B. considers the same steels, with steel B directly bonded to steel A using an AM process (by laser powder bed fusion process).
For the thermal behavior experiments and TCR determination, disc-shaped samples were required. In order to prepare samples for the two assembly configurations, samples of steel A were cut from a rod and machined with dimensions of \( \varnothing \, 72 \times 21 \) mm. Steel B discs were produced with the same dimensions as steel A discs by laser powder bed fusion (1.2709 steel) using Renishaw M300 maraging steel powder. A 400 W laser was used to obtain a 40 \( \mu \)m layer of steel per pass until a length of 21 mm was achieved. Samples A and B for the unbonded assembly (configuration A/B) were polished with P600 sandpaper to achieve an appropriate surface finish in the contact areas.

In the bonded assembly (configuration A.B.), unlike the unbonded assembly, in which the two discs are in contact, the steel B disc was directly deposited on the steel A disc by AM processing. For this latter configuration, sample A was finished using sandpaper with successive grits of P600, P1200, and P2000 prior to the deposition of steel B. On steel A disc, a surface roughness (Ra) of 0.015 \( \mu \)m was measured prior to steel deposition of disc B. Figure 1 is a schematic representation of the two assemblies under study, with the unbonded (A/B) and bonded (A.B.) configurations.

![Figure 1. Scheme showing the unbonded (A/B) and bonded (A.B.) steel disc configurations.](image)

In both assembly configurations, three holes were drilled to position the thermocouples to measure the samples’ temperature during the experiment. The thermocouple holes were separated by 120° around the circumference of the discs. The diameter and depth of the holes were 2 mm and 25 mm, respectively.

2.2. Sample Characterization

In the two studied configurations (A/B and A.B.), the two steels mimic the interface between the casting mold (sample A) and the cooling insert (sample B). Regarding the unbonded assembly, in which there is only a single contact between the insert and the mold, a proper fit must be established between the two samples (A and B). Roughness tests are crucial in the industrial setting, as they allow for the verification of the surface finish of the samples according to application requirements, including component adjustment, adhesion, and sealing, among others. The literature indicates that a good surface finish in the contact region between two materials, when subjected to heat flux, decreases the thermal conductivity ratio (TCR), boosting the heat transfer rate. The surface of the steel discs was evaluated for roughness using an SJ-210 portable roughness meter (Mitutoyo Corporation, Kawasaki, Japan, with Handysurf™ software, ver.1.05, Tokyo Seimitsu). The samples were measured along a linear measuring length of 16 mm at a constant speed of 0.25 mm/s in accordance with the ISO 1997 standard. In order to create a surface profile and to estimate the arithmetic mean roughness (Ra, \( \mu \)m), surface roughness was measured at several locations on each sample. The roughness of samples was measured in two orientations: (i) perpendicular to the polishing grooves and (ii) parallel to the polishing grooves. Six measurements were taken for each direction.
In the bonded assembly (configuration A.B.), the deposition of one steel part on another creates a link due to the laser’s effect on the steel powder used in the AM process and the base steel. In practice, the two steels exhibit a welding effect. SEM analysis of the bonded pair of steels was performed using an FEI Nova 200 (FEG/SEM) NanoSEM scanning electron microscope system. A smaller specimen was cut from the interface of the A.B. bonded configuration and prepared for SEM analysis (3 µm polishing). The analysis focused mainly on the interface between the steel (Orvar 2M, sample A) and steel (M300, sample B).

The thermal properties of the two assembly configurations under investigation were determined. Four contact pressures were tested between the steel discs. Thus, it was possible to monitor how the heat transfer efficiency, and we found that the TCR values were affected. The tests were conducted with an input power at 475 W when the system attained thermal equilibrium (temperature changes of less than 0.5 °C). Figure 2 depicts the experimental setup utilized for these studies.

![Figure 2. Heat transfer equipment.](image)

The experimental apparatus consists of a heat source and a heating resistor. The heating resistor, with a sleeve-style component wrapped around a copper cylinder, provides around 400 W of power. This whole ensemble is thermally insulated with rock wool to minimize heat losses. The copper cylinder is operated by a hydraulically driven cylinder, which maintains constant contact pressure between the copper cylinder and the metals throughout the test, and a manometer monitors the clamping pressure. The opposing end, which is cooled by a water stream, functions as a cold source. A steel structure protects the entire set. The samples were placed between the hot source (sample A) and the cold source (sample B). To ensure steady-state heat conduction, samples were wrapped in an insulating material (rock wool) to minimize heat loss.

The apparatus comprises eight K-type thermocouples to record temperatures: one in the hot source, three in each sample (spaced 6.5 mm apart), and one in the cold source. Two additional K-type thermocouples were installed on the outside structure to measure the surface temperature of the equipment, and one thermocouple was utilized to record the room temperature. These measurements were used to assess heat losses from the equipment surface. Figure 3 shows the arrangement of thermocouples inside the experimental apparatus.

The heating resistor imposes an input heat flux \( Q_e \), but a portion of this heat flux is lost \( Q_o \), leaving the effective heat flux \( Q_f \), which is conveyed to the sample material, as shown in Figure 4 and Equation (1).

\[
Q_f = Q_e - Q_o, \tag{1}
\]
The thermal contact conductance ($h_c$) can be calculated based on the values of the effective heat flux and the temperature change acquired by the thermocouples in the samples. This value is calculated by dividing the heat flow by the temperature gradient at the contact interface (Equation (2)):

$$h_c = \frac{Q_f}{A \Delta T},$$  \hspace{1cm} (2)

where $Q_f$ is the effective heat transfer rate, $A$ is the apparent contact area, and $\Delta T$ is the temperature difference at the interface, which is obtained by extrapolating the temperature profiles recorded in each material. These parameters are associated with $TCR$ through Equation (3):

$$TCR = \frac{1}{h_c} = \frac{\Delta T}{Q_f/A},$$  \hspace{1cm} (3)

The TCR is the inverse of thermal contact conductance. The TRC concept is used to describe the influence of contact on heat transmission. With these tests, the TCR value can be determined as a function of surface roughness and contact pressure. These data may then be used in numerical simulation to determine the required degree of surface polish in the mold/insert contact areas. Therefore, it is feasible to provide additional assembly arrangements without wasting time or money.
To test the bonded (A.B.) and unbonded (A/B) configurations, the samples were positioned in the equipment such that sample A was always in contact with the hot source and sample B was always in contact with the cold source. In the unbonded configuration (A/B), both samples were adjusted such that the entire surfaces of both materials were in contact. The resistors and water to cool the cold zone were connected after assembly, and then contact pressure was applied. Four distinct contact pressures were used throughout the tests: 0 bar, 50 bar, 75 bar, and 100 bar. The temperatures measured by each thermocouple were recorded as soon as the system attained a steady-state temperature.

3. Results and Discussion

Prior to evaluation of the thermal behavior of both configurations, the roughness on the contact surfaces of steel disc samples A and B were measured. Figure 5 shows one of the profile curves registered from A and B steel disc surfaces. According to the recorded profiles, the arithmetic mean roughness measured on the surfaces was identical between the samples: Ra of 0.05 µm.

![Profile Curve](image)

Figure 5. Roughness profile curves measured on steel sample contact surfaces: (a) surface A; (b) surface B.

Despite having the same roughness (0.05 µm), samples A and B exhibited distinct roughness patterns. The surface of sample B, which was manufactured using AM, has a more uniform surface than that of sample A for the same surface finish (P600).

Figure 6 shows a SEM image of the transition zones resulting from the laser effect on the steel powder used in the AM process. Analysis focused on the interface between the two steels reveals the AM deposition layers, particularly in the zone of transition between the two steels. The image clearly demonstrates the adherence of the sample B steel to the sample A steel. Furthermore, the laser used in the AM process melted the surface of the base steel of sample A during the deposition of the first layer.
In both configurations (A/B and A.B.), contact pressures were evaluated between 0 and 100 bar. The temperature profiles of the two configurations vary for all measured contact pressures (Figure 7). The bonded configuration (A.B.) between steel sample A and B has a continuous and fully linked interface. For unbonded (A/B) configuration, as the two steels samples are not exactly matched, there is a gap at the contact interface, which increases the TCR value. For both configurations, based on experimental measurements and using Equation (1) through (3), $Q_f$ and $h_c$ values were calculated for the various tested contact pressures (Table 1). TCR values were also calculated for the unbonded configuration. Table 1 displays the results of the experimental tests conducted on the two configurations, including the rate of heat transfer ($Q_f$), the interfacial conductance between T3 and T4 ($h_c$), and the predicted TCR.

### Table 1. Thermal tests conditions and results for the unbonded (A/B) and bonded (A.B.) configurations with contact pressures of 0, 50, 75, and 100 bar.

<table>
<thead>
<tr>
<th>Contact Pressure (bar)</th>
<th>$Q_f$ (W)</th>
<th>$h_c$ (W/m²·°C)</th>
<th>$TCR \times 10^4$ (m²·K/W)</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Unbonded (A/B) configuration</strong></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>385</td>
<td>4395</td>
<td>2.28</td>
</tr>
<tr>
<td>50</td>
<td>386</td>
<td>4574</td>
<td>2.19</td>
</tr>
<tr>
<td>75</td>
<td>388</td>
<td>5142</td>
<td>1.94</td>
</tr>
<tr>
<td>100</td>
<td>389</td>
<td>6791</td>
<td>1.47</td>
</tr>
<tr>
<td><strong>Bonded (A.B.) configuration</strong></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>0</td>
<td>374</td>
<td>26,160</td>
<td>-</td>
</tr>
<tr>
<td>50</td>
<td>375</td>
<td>21,417</td>
<td>-</td>
</tr>
<tr>
<td>75</td>
<td>379</td>
<td>22,415</td>
<td>-</td>
</tr>
<tr>
<td>100</td>
<td>383</td>
<td>23,401</td>
<td>-</td>
</tr>
</tbody>
</table>

Increasing contact pressure causes an increase in thermal conductance ($h_c$) between T3 and T4 in the unbonded (A/B) configuration (Table 1). With a contact pressure of 100 bar, the initial calculated value for 0 bar increases by 54%. Because the TCR is the inverse of conductance ($h_c$) (Equation (3)), for identical contact pressure, the TCR value resulted in an increase of 36% (100 bar). The $h_c$ values for a bonded (A.B.) configuration behave differently. There is no correlation between contact pressure and conductance, whereas the conductance ($h_c$) is decreased at contact pressures greater than 0 bar. In general, the interfacial conductance between T3 and T4 (Figure 3) is much more significant in the bonded (A.B.) configuration compared to the unbonded (A/B) configuration. The union
of samples A and B in a bonded (A.B.) configuration permits an increased in thermal conductivity ($h_c$) by four to six times compared with the unbonded (A/B) configuration.

Figure 7. Temperature profiles at the interface between the unbonded (A/B) and bonded (A.B.) configurations at the following contact pressures: (a) 0 bar, (b) 50 bar, (c) 75 bar, and (d) 100 bar.

Figure 7 shows the temperature profiles at the interface between the unbonded (A/B) and bonded (A.B.) configurations in a thermally steady state. These temperature profiles were recorded at contact pressures ranging from 0 to 100 bar.

The values for the bonded (A.B.) configuration presented in the graphs show a higher thermal profile compared to the unbonded (A/B) configuration, indicating this system’s relatively higher heat transfer capacity. This is true regardless of the location of the temperature measurement in the sample or the measured contact pressure. These findings complement those presented in Table 1, demonstrating that the conductance is much larger in the bonded (A.B.) configuration than in the unbonded (A/B) configuration, allowing for increased thermal diffusivity between samples A and B. Furthermore, when contact pressure (and also $h_c$) increases, the temperature profile of the unbonded (A/B) configuration approaches that of the bonded (A.B.) configuration. However, whereas a temperature step is detected at the A/B interface (unbonded (A/B) configuration), the temperatures in the transition zone from sample A steel to sample B sample are reduced only very marginally in the bonded (A.B.) configuration.

Figure 8 shows the development of the temperature profile with contact pressures in bonded samples. These data enable evaluation of the influence of pressure on the system’s hot and cold points, as no interface losses occur in the bonded (A.B.) configurations. According to our findings, the system reaches equilibrium at lower temperatures when the contact pressure is increased. The increase in contact pressure seems to enhance the contact between the samples and the hot and cold ends of the system, reducing heat loss at these
connection points. Overall, the temperature of the samples decreased from the hot source to the cold source.

![Temperature profile for the bonded (A.B.) configuration with varying compression pressures.](image)

As shown in Figure 8, the temperature decline in sample B is more pronounced than that in sample A. This observation is consistent with the thermal conductivity values for samples A and B. The thermal conductivity of sample A steel ($k_A$) at the tested temperature (380 °C) is 27 W/m·K, whereas that of sample B steel ($k_B$) is 18 W/m·K.

The temperature reduction from T1 (near the heat source) to T6 (at the end of the unbonded (A/B) and bonded (A.B.) configuration) is shown in Table 2 (near the cold source). Overall, there is a reduced temperature decrease in the system at 0 bar for both configurations. From 0 to 50 bar, the thermal reduction increased by ~20 °C. The thermal reduction did not significant differ between 50 and 100 bar. The heat transfer rate ($Q_f$) rises as contact pressure increases (Table 1). However, with this increase in heat flow, the losses associated with the thermal path also increase, resulting in an enhanced thermal reduction (Table 2). In addition, the temperature decrease in the unbonded (A/B) configuration is larger than that of the bonded (A.B.) configuration. Due to heat losses associated with the A/B contact, the unbonded (A/B) configuration exhibits greater thermal resistance than the bonded (A.B.) configuration (TCR). The unbonded (A/B) configuration requires a higher temperature to attain thermal equilibrium, whereas the bonded (A.B.) configuration reaches equilibrium at lower temperatures. This explains the larger temperature decline of the unbonded (A/B) configuration.

**Table 2.** Temperature reduction in the unbonded (A/B) and bonded (A.B.) configurations from T1 to T6.

<table>
<thead>
<tr>
<th>Contact Pressure (bar)</th>
<th>T1–T6 Temperature Reduction (°C)</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>Unbonded (A/B)</td>
</tr>
<tr>
<td>0</td>
<td>91</td>
</tr>
<tr>
<td>50</td>
<td>112</td>
</tr>
<tr>
<td>75</td>
<td>112</td>
</tr>
<tr>
<td>100</td>
<td>115</td>
</tr>
</tbody>
</table>

4. Conclusions

The impact of contact between two samples of 1.2344 and 1.2709 steels on the heat transmission through these components was investigated by mimicking the contact between a steel die-casting mold (1.2344) and an AM-produced steel insert with conformal cooling channels (1.2709). The contact between the two steel samples was investigated with the steels leaning on one another (unbonded configuration) and with the 1.2709 steel directly placed on the 1.2344 steel (bonded configuration).

The two steel samples were initially characterized. The surface finish in the contact regions of unbonded steel samples presented a roughness of 0.05 µm according to standard...
testing. In addition, SEM research revealed that the bonded configuration produced by AM resulted in a complete union of the two steels.

When the contact pressure was increased from 0 to 100 bar, the system equilibrium was attained at lower temperatures according to the results of thermal experiments. The increase in contact pressure seems to enhance the contact between the samples and the hot and cold ends of the system, reducing energy loss in these connections.

In addition, heat testing revealed that a well-defined resistance does not emerge between the two steels in the bonded configuration as it does in the unbonded configuration. In the transition zone of the thermal profiles of the bonded configuration, the temperature reduction from steel 1.2344 to steel 1.2709 is minimal. In contrast, the temperature profile of the unbonded configuration reveals a temperature step at the contact interface, which decreases from 49 to 40 degrees with increasing compaction pressure (from 0 to 100 bar). Each of these steps correspond to a TCR.

The heat flow in an A-B system is contingent on the thermal conduction properties of the system. These characteristics vary depending on the contact configuration of the assembly and the system’s contact pressure. As contact pressure increases from 0 to 100 bar, the temperature profiles of bonded and unbonded steel samples tend to converge. The contact area between the two steels expands with increasing pressure in the unbonded configuration. As a result, heat conduction increases, and heat losses associated with this interface decrease. The increase in contact pressure seems to enhance the contact between the samples and the hot and cold ends of the system, reducing heat loss in these connections.

Despite the variation in heat conductivity properties of the two tested steels, combining the mold and insert in a bonded configuration may considerably reduce the interface resistance, despite being a permanent solution. In this manner, the cooling by heat transfer in a die-casting mold can be optimized.


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